

### 1 Product profile

### 1.1 General description

Planar PIN diode in a SOD523 ultra small SMD plastic package.

#### 1.2 Features and benefits

- High voltage; current controlled RF resistor for attenuators
- · Low diode capacitance
- · Very low series inductance
- · AEC-Q101 qualified

### 1.3 Applications

- RF attenuators
- (SAT) TV
- · Car radio

### 2 Pinning information

Table 1. Discrete pinning

Pin	Description	Simplified outline	Symbol
1	cathode		14
2	anode	1 2	sym006

# 3 Ordering information

**Table 2. Ordering information** 

Type number	Package		
	Name	Description	Version
BAP70-02	-	plastic surface-mounted package; 2 leads	SOD523



Silicon PIN diode

### 4 Marking

#### Table 3. Marking

Type number	Marking code
BAP70-02	K8 <sup>[1]</sup>

<sup>[1]</sup> The marking bar indicates the cathode (see simplified outline graphic in <u>Table 1</u>)

## 5 Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_R$	reverse voltage	continuous voltage	-	50	V
I <sub>F</sub>	forward current	continuous current	-	100	mA
P <sub>tot</sub>	total power dissipation	T <sub>sp</sub> ≤ 90 °C	-	415	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-65	+150	°C

### 6 Thermal characteristics

**Table 5. Thermal characteristics** 

Symbol	Parameter	Conditions	Тур	Unit
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		145	K/W

### 7 Characteristics

#### **Table 6. Characteristics**

 $T_j$  = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 50 mA	-	0.9	1.1	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 50 V	-	-	100	nA
C <sub>d</sub>	diode capacitance	f = 1 MHz (see <u>Figure 1</u> )				
		V <sub>R</sub> = 0 V	-	570	-	fF
		V <sub>R</sub> = 1 V	-	400	-	fF
		V <sub>R</sub> = 5 V	-	270	-	fF
		V <sub>R</sub> = 20 V	-	200	250	fF

### Silicon PIN diode

Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
$r_D$	diode forward resistance	f = 100 MHz (see Figure 2)	f = 100 MHz (see <u>Figure 2</u> )				
		I <sub>F</sub> = 0.5 mA	-	77	100	Ω	
		I <sub>F</sub> = 1 mA	-	40	50	Ω	
		I <sub>F</sub> = 10 mA	-	5.4	7	Ω	
		I <sub>F</sub> = 100 mA	-	1.4	1.9	Ω	
τι	charge carrier life time	when switched from $I_F$ = 10 mA to $I_R$ = 6 mA; $R_L$ = 100 $\Omega$ ; measured at $I_R$ = 3 mA	-	1.25	-	μs	
L <sub>S</sub>	series inductance	I <sub>F</sub> = 100 mA; f = 100 MHz	-	0.6	-	nH	

## 8 Graphical data

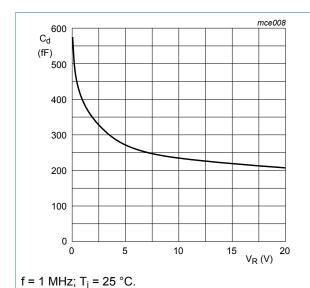
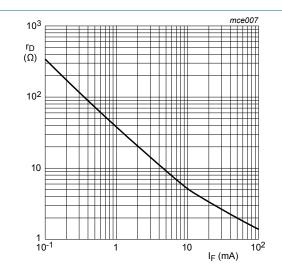


Figure 1. Diode capacitance as a function of reverse voltage (typical values)

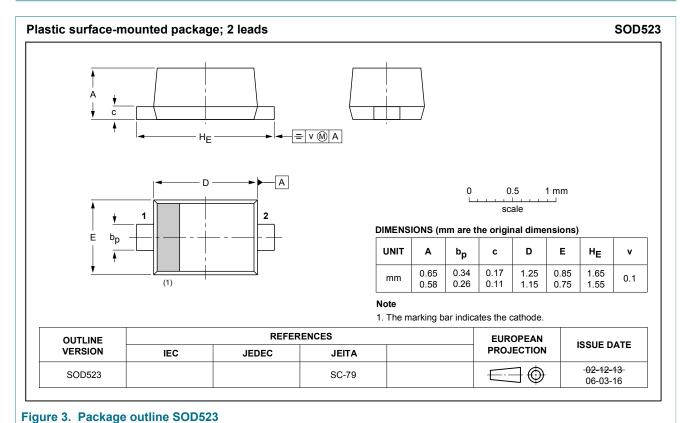


f = 100 MHz;  $T_i = 25 ^{\circ}\text{C}$ .

Figure 2. Diode forward resistance as a function of forward current (typical values)

Silicon PIN diode

## 9 Package outline



10 Abbreviations

# Table 7. Abbreviations

Acronym	Description
PIN	P-type, Intrinsic, N-type
SMD	Surface-Mounted Device
RF	Radio Frequency

Silicon PIN diode

# 11 Revision history

#### Table 8. Revision history

		_		-
Document ID	Release date	Data sheet status	Change notice	Supersedes
BAP70-02 v.8	20181211	Product data sheet	-	BAP70-02 v.7
Modifications:		tures and benefits" has been up nation" pages have been updat		
BAP70-02 v.7	20140416	Product data sheet	-	BAP70-02 v.6
BAP70-02 v.6	20140211	Product data sheet	-	BAP70-02_N v.5
BAP70-02_N v.5	20080102	Product data sheet	-	BAP70-02_N v.4
BAP70-02_N v.4	20070322	Product data sheet	-	BAP70-02 v.3
BAP70-02 v.3 (9397 750 10093)	20020806	Product data sheet	-	BAP70-02_N v.2
BAP70-02_N v.2 (9397 750 10079)	20020702	Preliminary data sheet	-	BAP70-02_N v.1
BAP70-02_N v.1 (9397 750 09578)	20020402	Preliminary data sheet	-	-

Silicon PIN diode

### 12 Legal information

#### 12.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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Silicon PIN diode

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### Silicon PIN diode

### **Contents**

1	Product profile	1
1.1	General description	
1.2	Features and benefits	1
1.3	Applications	1
2	Pinning information	
3	Ordering information	
4	Marking	
5	Limiting values	
6	Thermal characteristics	
7	Characteristics	
8	Graphical data	3
9	Package outline	
10	Abbreviations	
11	Revision history	
12	Legal information	

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